SPECIFICATION FOR APPROVAL

COMMODITY: 3mm Round Cylindrical With InnerType 850nm Infrared LED

DEVICE NUMBER: DL-304SIRCE-1SIR100

CUSTOMER APPROVEDBY	DATE

Features:

- 1. Popular 3mm round cylindrical with inner type package.
- 2. High efficiency.
- 3. Reliable and robust.
- 4. Industrial standard footprint.
- 5. The product itself will remain within RoHS compliant Version.

♦ Descriptions:

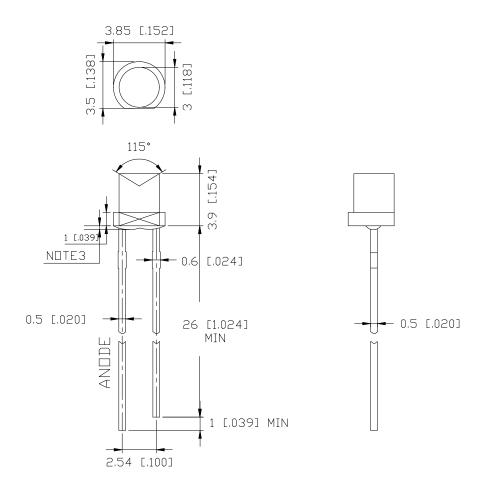
- 1. The LED lamps are available with different colors, intensities.
- 2. Utilizing advanced InGaN chip technology.

♦ Applications:

- 1. Floppy disk drive.
- 1. Optoelectronic switch.
- 2. Camera.
- 3. Free air transmission system.
- 4. Video.

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♦ Package dimensions:



Part No.	No. Chip Material Lens Color		Source Color
DL-304IRCE-1SIR100	DL-304IRCE-1SIR100 GaAlAs		Infrared

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm (0.01") unless otherwise specified.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

◆ Absolute Maximum Ratings at Ta=25°C

Parameter	MAX.	Unit
Power Dissipation	100	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	1000	mA
Continuous Forward Current	100	mA
Derating Linear From 50℃	0.4	mA/℃
Reverse Voltage	5	V
Operating Temperature Range	-40°C to +85°C	
Storage Temperature Range	-40°C to +105°C	
Lead Soldering Temperature [4mm(.157") From Body]	260℃ for 5 Seconds	

Electrical Optical Characteristics at Ta=25 ℃

trical Optical characteristics at 14–25 C						
Parameters	Symbol	Min.	Тур.	Max.	Unit	Test Condition
	Ee	13	26.0			IF=20mA
Radiant Intensity (Note 1) *			38.0		mW/sr	I _F =100mA, tp=100μs, tp/T=0.01
Viewing Angle (Note 2) *	201/2		100		Deg	IF=20mA
Peak Emission Wavelength	λр		850		nm	IF=20mA (Note 3)
Spectral Bandwidth	Δλ		50		nm	IF=20mA
		1.00	1.30	1.50	V	IF=20mA
Forward Voltage	VF		1.60	1.80		I _F =100mA, tp=100μs, tp/T=0.01
Reverse Current	IR			10	μA	V _R =5V

Notes:

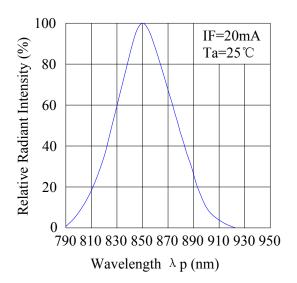
- 1. Luminous (Radiant) Intensity Measurement allowance is \pm 10%.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength (λp) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Typical Electrical - Optical Characteristics Curves

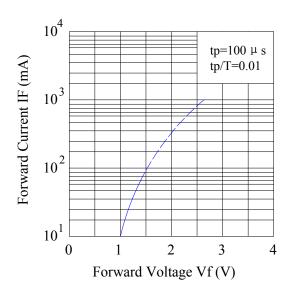
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(25°C Ambient Temperature Unless Otherwise Noted)

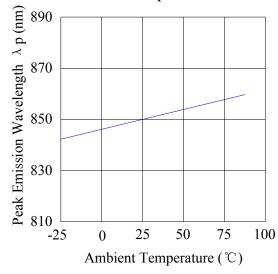
Spectral Distribution



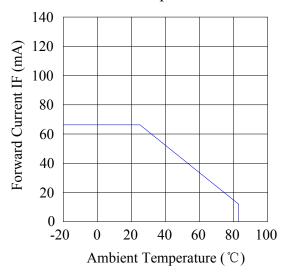
Forward Current & Forward Voltage



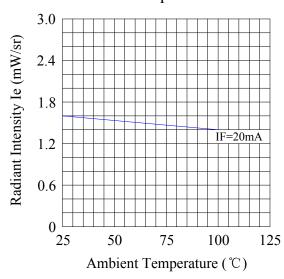
Peak Emission Wavelength & Ambient Temperature



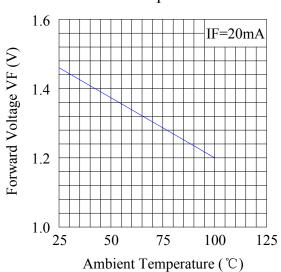
Forward Current & Ambient Temperature



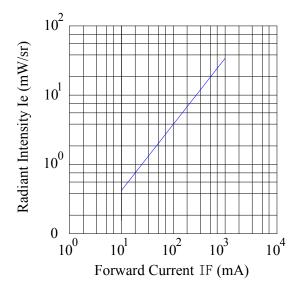
Relative Intensity & Ambient Temperature



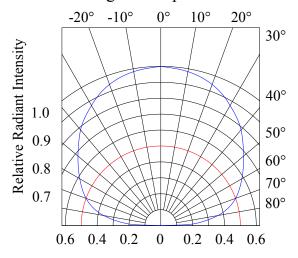
Forward Voltage & Ambient Temperature



Relative Intensity & Forward Current



Relative Radiant Intensity & Angular Displacement



♦ Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result	
	Operation Life	MIL-STD-750:1026	Connect with a power If=20mA		
		MIL-STD-883:1005	Ta=Under room temperature	0/20	
		JIS-C-7021 :B-1	Test time=1,000hrs		
	High Temperature	MIL-STD-202:103B	Ta=+65℃±5℃		
	High Humidity	JIS-C-7021 :B-11	RH=90%-95%	0/20	
	Storage		Test time=240hrs		
Endurance Test	High Temperature	MIL-STD-883:1008	High Ta=85℃±5℃	0/20	
	Storage	JIS-C-7021 :B-10	Test time=1,000hrs 0/20	0/20	
	Low Temperature	JIS-C-7021 :B-12	Low Ta=-35 ℃±5 ℃	0/20	
	Storage		Test time=1,000hrs		
	Temperature	MIL-STD-202:107D	-35°C ~ +25°C ~ +85°C ~ +25		
	Cycling	MIL-STD-750:1051	$^{\circ}$ C	0/20	
		MIL-STD-883:1010	60min 20min 60min 20min		
		JIS-C-7021 :A-4	Test Time=5cycle		
Environmental	Thermal Shock	MIL-STD-202:107D	35℃±5℃ ~+85℃±5℃	0/20	
Test		MIL-STD-750:1051	20min 20min	0/20	
		MIL-STD-883:1011	Test Time=10cycle		
	Solder Resistance	MIL-STD-202:201A	Preheating:		
		MIL-STD-750:2031	140 $^{\circ}$ C-160 $^{\circ}$ C, within 2 minutes.	0/20	
		JIS-C-7021 :A-1	Operation heating: 235 °C		
			(Max.), within 10seconds (Max.)		

♦ Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	VF (V)	IF=20mA	Over Ux1.2
Reverse current	IR(uA)	VR=5V	Over Ux2
Luminous intensity	Iv (mcd)	IF=20mA	Below SX0.5

Notes:

- 1. U means the upper limit of specified characteristics. S means initial value.
- 2. Measurement shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

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Soldering:

1. Manual of Soldering

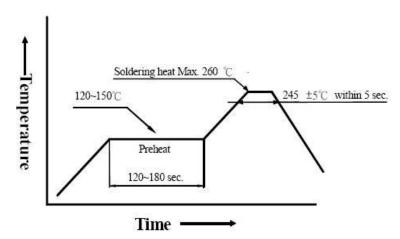
The temperature of the iron tip should not be higher than 300°C (572°F) and Soldering within 3 seconds per solder-land is to be observed.

2. Reflow Soldering

Preheating: 140° C $^{\sim}160^{\circ}$ C $^{\pm}5^{\circ}$ C, within 2 minutes.

Operation heating: 235°C (Max.) within 10 seconds (Max)

Gradual Cooling (Avoid quenching).

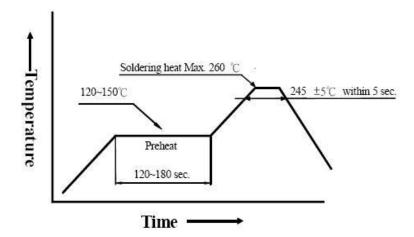


3. DIP soldering (Wave Soldering):

Preheating: 120° C ~ 150° C, within 120° 180 sec.

Operation heating: $245^{\circ}C \pm 5^{\circ}C$ within 5 sec.260°C (Max)

Gradual Cooling (Avoid quenching).



Handling:

Care must be taken not to cause to the epoxy resin portion of LEDs while it is exposed to high temperature. Care must be taken not rub the epoxy resin portion of LEDs with hard or sharp article such as the sand blast and the metal hook.

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♦ Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the LEDs within the rated figures. Also, caution should be taken not to overload LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as be subjected to reverse voltage when turning off the LEDs.

♦ Storage:

In order to avoid the absorption of moisture, it is recommended to solder LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- 1) Temperature : 5° C-30°C (41°F), Humidity : RH 60% Max.
- 2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
 - a) Completed within 24 hours.
 - b) Stored at less than 30% RH.
- 3) Devices require baking before mounting, if (2) a or (2) b is not met.
- 4) If baking is required, devices must be baked under below conditions: 12 hours at $60^{\circ}\text{C} \pm 3^{\circ}\text{C}$.

♦ Package and Label of Products:

Products are packed in one bag of 500pcs (one taping reel) and a label is attached on each bag.

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